

# FMP60N120E7

## N-Channel *e*MOS E7 Power MOSFET

600 V, 27 A, 120 mΩ



### Description

The 600V *e*MOS E7 is an advanced Faster Semiconductor's Super Junction MOSFET family by utilizing charge balance technology for excellent low on-resistance and gate charge.

This technology combines the benefits of a fast switching performance with ease of usage and robustness.

Consequently, the *e*MOS E7 family is suitable for application requiring high power density and superior efficiency.

### Features

$BV_{DSS}$ @ $T_{J,max}$	$I_D$	$R_{DS(on),max}$	$Q_{g,typ}$
650 V	27 A	120 mΩ	43.6 nC

- Reduced Switching & Conduction Losses
- Lower Gate Resistance
- 100% Avalanche Tested
- Pb-free, Halogen Free, and RoHS Compliant

### Applications

- PFC, Hard & Soft Switching Topologies
- Industrial & Consumer Power Supplies



### Absolute Maximum Ratings ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Value	Unit
$V_{DSS}$	Drain to Source Voltage		600	V
$V_{GSS}$	Gate to Source Voltage		$\pm 30$	V
$I_D$	Drain Current	Continuous ( $T_C = 25^\circ\text{C}$ )	27	A
		Continuous ( $T_C = 100^\circ\text{C}$ )	17.3	
$I_{DM}$	Drain Current	Pulsed (Note1)	81	A
$E_{AS}$	Single Pulsed Avalanche Energy		(Note2)	164 mJ
$I_{AS}$	Avalanche Current		(Note2)	5.1 A
$E_{AR}$	Repetitive Avalanche Energy		(Note1)	2.23 mJ
$dv/dt$	MOSFET $dv/dt$		100	V/ns
	Peak Diode Recovery $dv/dt$		(Note3)	
$P_D$	Power Dissipation	( $T_C = 25^\circ\text{C}$ )	223	W
		Derate Above $25^\circ\text{C}$	1.79	
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 to 150	°C
$T_L$	Maximum Lead Temperature for Soldering, 1/8" from Case for 10 Seconds		260	°C

### Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.56	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

**Package Marking and Ordering Information**

Part Number	Top Marking	Package	Packing Method	Quantity
FMP60N120E7	FMP60N120E7	TO-220	Tube	50 units

**Electrical Characteristics** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
--------	-----------	-----------------	-----	-----	-----	------

**Off Characteristics**

BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			V
		$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 150^\circ\text{C}$	650			
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$			1	\mu\text{A}
		$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125^\circ\text{C}$		2		
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$			$\pm 100$	nA

**On Characteristics**

$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1.8 \text{ mA}$	2.5		4.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 12.6 \text{ A}$		103	120	m\Omega

**Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, f = 250 \text{ kHz}$		1827		pF
C <sub>oss</sub>	Output Capacitance			48.9		pF
C <sub>o(tr)</sub>	Time Related Output Capacitance	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		500		pF
C <sub>o(er)</sub>	Energy Related Output Capacitance			78		pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	$V_{DS} = 400 \text{ V}, I_D = 12.6 \text{ A}, V_{GS} = 10 \text{ V}$		43.6		nC
Q <sub>gs</sub>	Gate to Source Charge			9.6		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			20.2		nC
R <sub>G</sub>	Gate Resistance	f = 1MHz		1		\Omega

**Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DS} = 400 \text{ V}, I_D = 12.6 \text{ A}, V_{GS} = 10 \text{ V}, R_G = 10 \Omega$ See Figure 13		15		ns
t <sub>r</sub>	Turn-On Rise Time			9		ns
t <sub>d(off)</sub>	Turn-Off Delay Time			76		ns
t <sub>f</sub>	Turn-Off Fall Time			10		ns

**Source-Drain Diode Characteristics**

I <sub>S</sub>	Maximum Continuous Diode Forward Current			27	A	
I <sub>SM</sub>	Maximum Pulsed Diode Forward Current			81	A	
V <sub>SD</sub>	Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{SD} = 12.6 \text{ A}$			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{DD} = 400 \text{ V}, I_{SD} = 12.6 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$		300		ns
Q <sub>rr</sub>	Reverse Recovery Charge			4.1		\mu\text{C}

## ※Notes:

- Repetitive rating: pulse-width limited by maximum junction temperature.
- $I_{AS} = 5.1 \text{ A}, R_G = 25 \Omega, \text{starting } T_J = 25^\circ\text{C}.$
- $I_{SD} \leq 12.6 \text{ A}, di/dt \leq 100 \text{ A}/\mu\text{s}, V_{DD} \leq 400 \text{ V}, \text{starting } T_J = 25^\circ\text{C}.$

## Typical Performance Characteristics

Figure 1. On-Region Characteristics

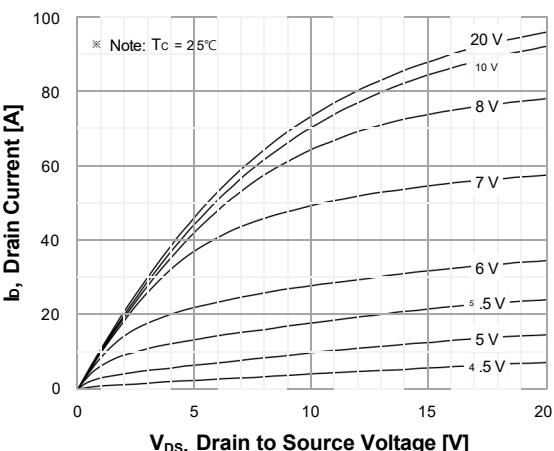


Figure 2. Transfer Characteristics

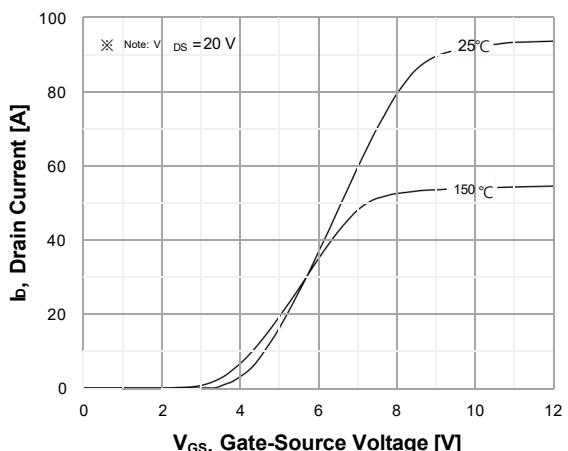


Figure 3. On-Resistance Characteristics vs. Drain Current and Gate Voltage

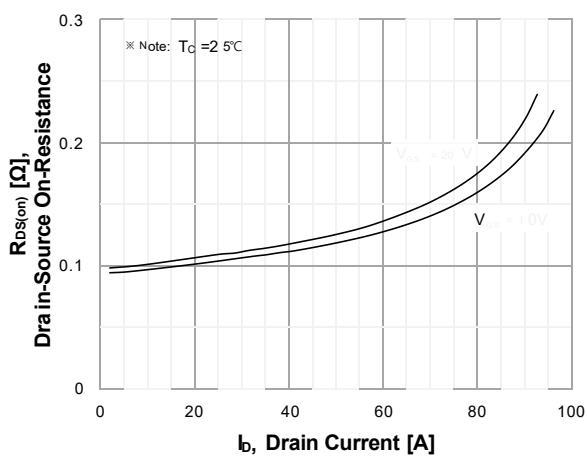


Figure 4. Diode Forward Voltage Characteristics vs. Source-Drain Current and Temperature

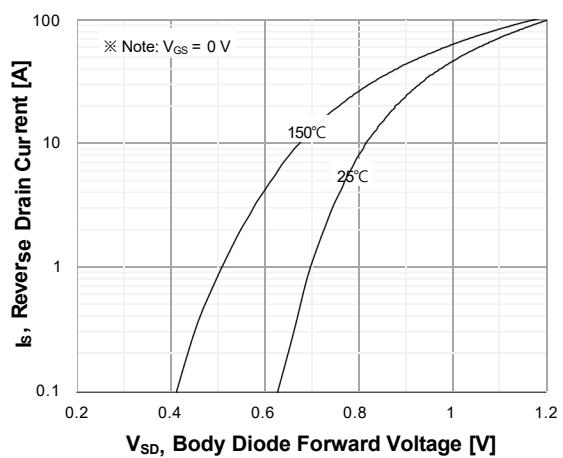


Figure 5. Capacitance Characteristics

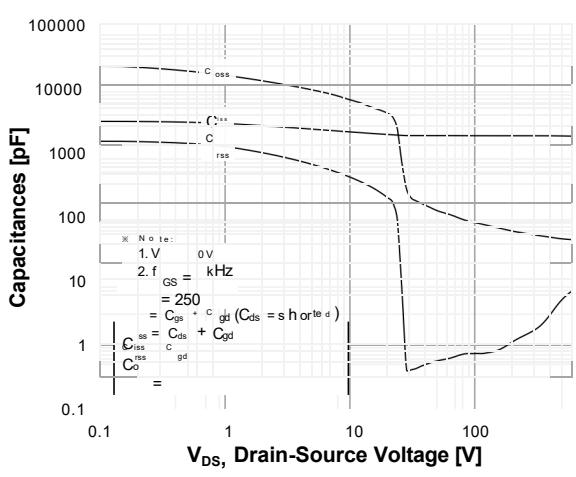
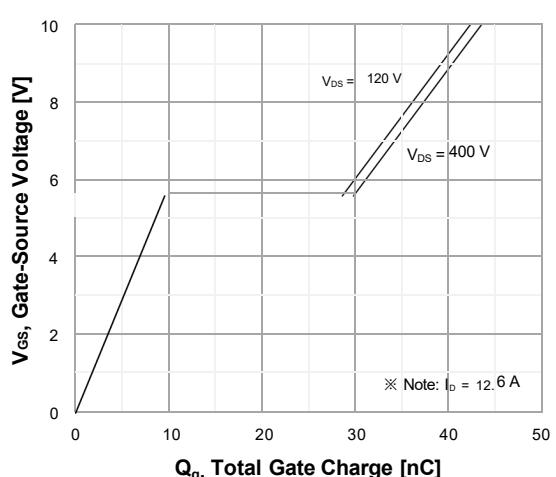
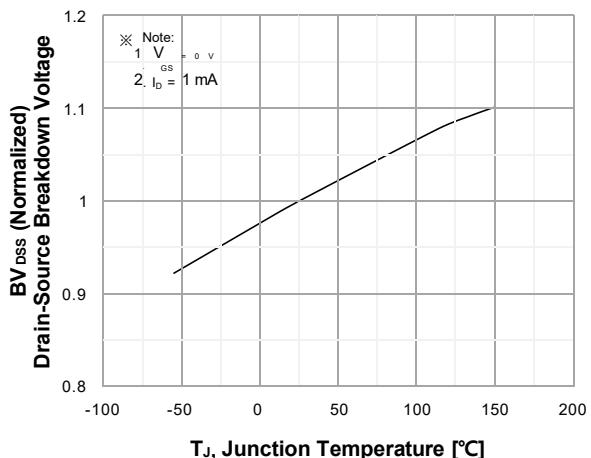


Figure 6. Gate Charge Characteristics

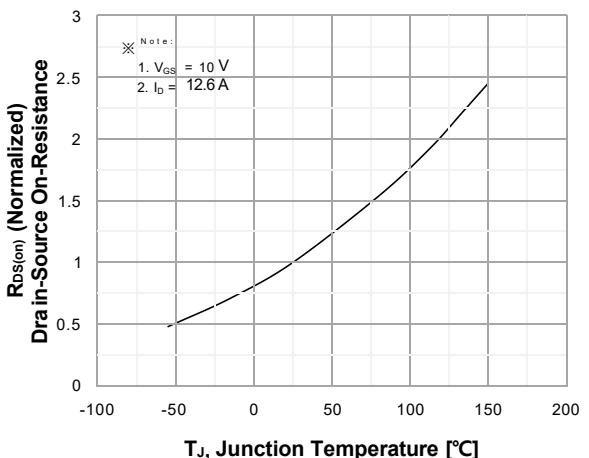


### Typical Performance Characteristics

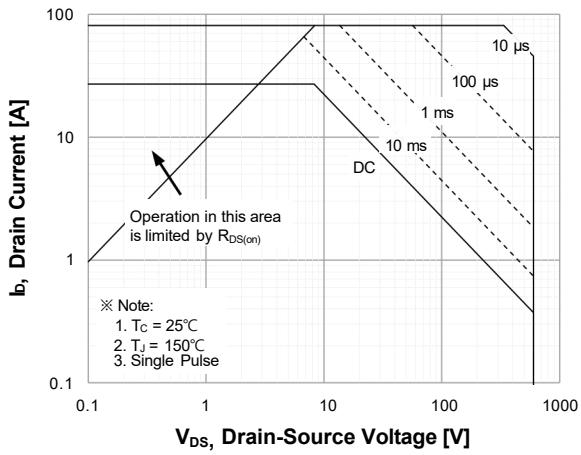
**Figure 7. Breakdown Voltage Characteristics vs. Temperature**



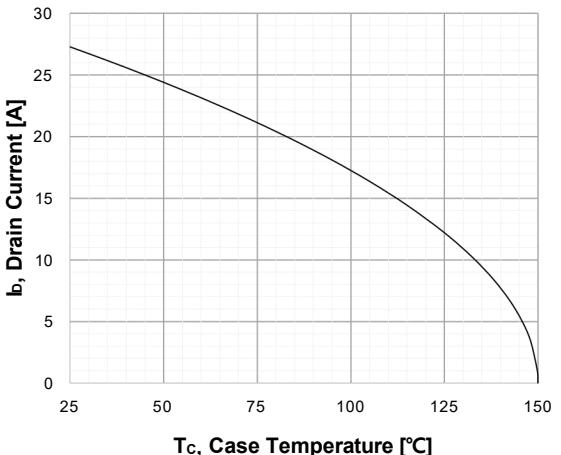
**Figure 8. On-Resistance Characteristics vs. Temperature**



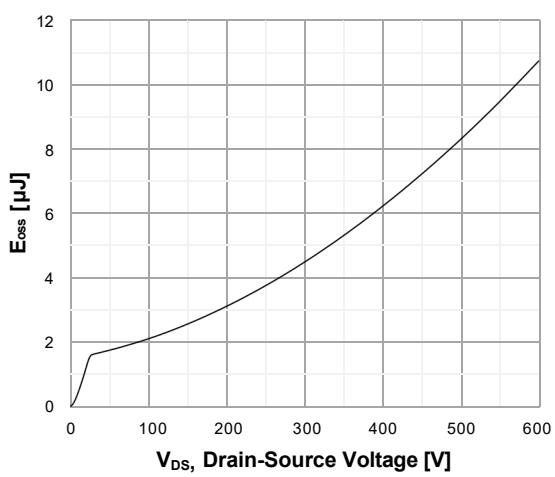
**Figure 9. Maximum Safe Operating Area**



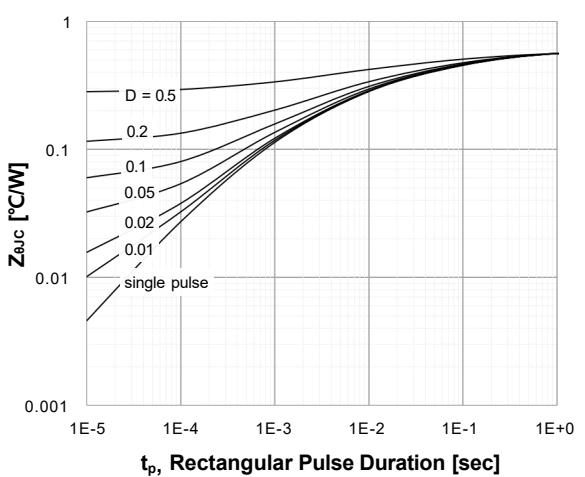
**Figure 10. Maximum Drain Current vs. Case Temperature**



**Figure 11.  $E_{oss}$  vs. Drain to Source Voltage**

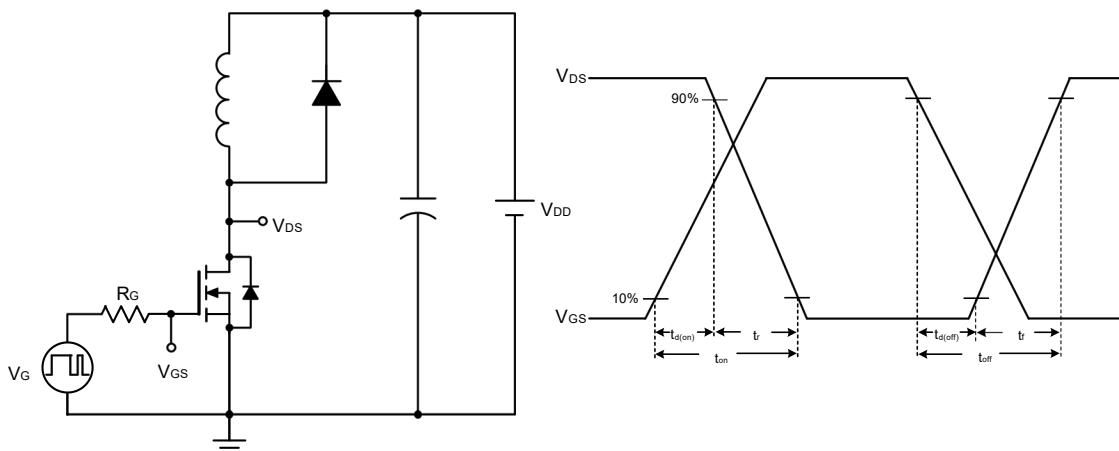


**Figure 12. Transient Thermal Response Curve**

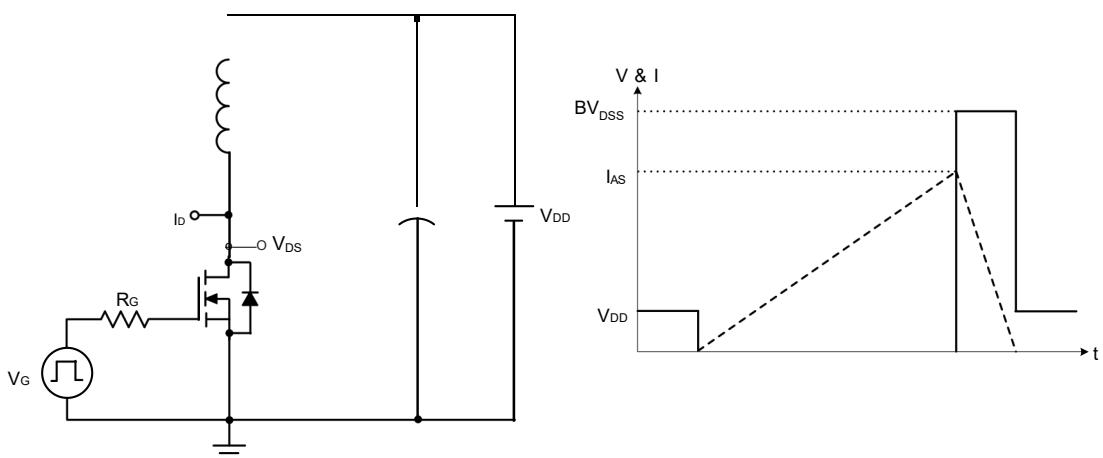


## Test Circuits

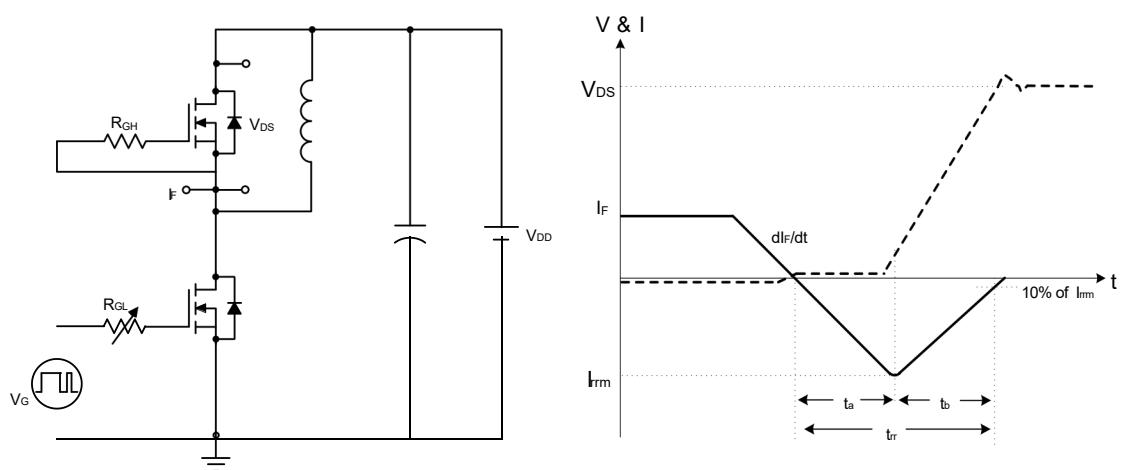
**Figure 13. Inductive Load Switching Test Circuit and Waveforms**



**Figure 14. Unclamped Inductive Switching Test Circuit and Waveforms**

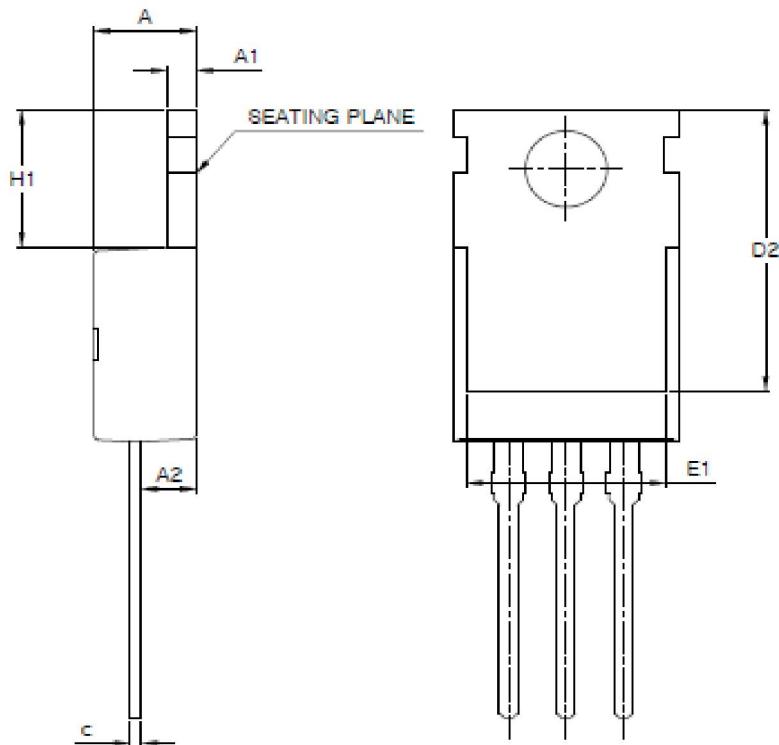
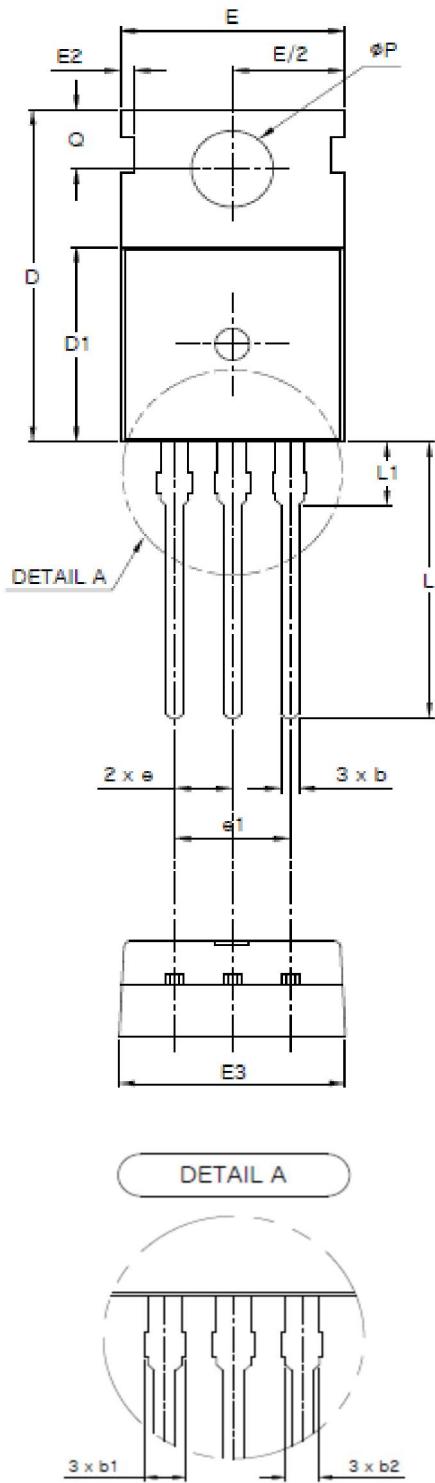


**Figure 15. Peak Diode Recovery dv/dt Test Circuit and Waveforms**



## Package Outlines

## TO-220



SYMBOL	MIN	NOM	MAX
A	4,30	4,50	4,70
A1	1,25	1,30	1,40
A2	2,20	2,40	2,60
b	0,70	0,80	0,90
b1	1,42	1,52	1,62
b2	1,17	1,27	1,37
c	0,45	0,50	0,60
D	15,50	15,70	15,90
D1	9,00	9,20	9,40
D2	13,10	13,30	13,50
E	9,70	9,90	10,10
E1		(8,80)	
E2		(0,60)	
E3	9,80	10,00	10,20
e		2,54 BSC	
e1		5,08 BSC	
H1	6,30	6,50	6,70
L	12,88	13,08	13,28
L1		(3,00)	
φP	3,40	3,60	3,80
Q	2,70	2,80	2,90

\* Dimensions in millimeters